

## General Description

The CD4017 is a 5-stage Johnson decade counter with ten spike-free decoded active HIGH outputs (Q0 to Q9), an active LOW carry output from the most significant flip-flop (Q5—9), active HIGH and active LOW clock inputs (CP0,—CP1) and an overriding asynchronous master reset input (MR).

The counter is advanced by either a LOW-to-HIGH transition at CPO while PI is LOW or a HIGH-to-LOW transition at CP1 while CPO is HIGH.

When cascading counters, the Q5-9 output, which is LOW while the counter is in states 5,6,7,8, and 9, can be used to drive the CPO input of the next counter. A HIGH on MR resets the counter to zero (Q0=Q5-9=HIGH; Q1 to Q9=LOW) independent of the clock inputs (CP0,CP1).

Automatic counter code correction is provided by an internal circuit: following any illegal code the counter returns to a proper counting mode within 11 clock pulses.

It operates over a recommended VDD power supply range of 3 V to 15 V referenced to VSS (usually ground). Unused inputs must be connected to VDD, VSS, or another input.

## Features

- Wide supply voltage range from 3V to 15V
- Automatic counter correction
- Tolerant of slow clock rise and fall times
- 5V,10V, and 15V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40°C to +85°C
- Packaging information: DIP16/SOP16/TSSOP16

## Order Information

DEVICE	Package Type	MARKING	Packing	Packing QTY
CD4017BE/CD4017BN	DIP-16	CD4017B	TUBE	2000/box
CD4017BM/TR	SOP-16	CD4017B	REEL	2500/reel
CD4017BMT/TR	TSSOP-16	CD4017B	REEL	2500/reel

## 2. Block Diagram And Pin Description

2.1 、Block Diagram

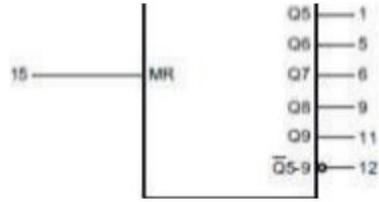


Figure 1.Logic symbol

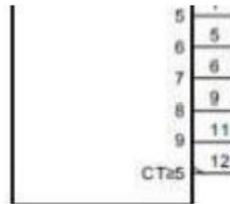


Figure 2 IEE logic symbol

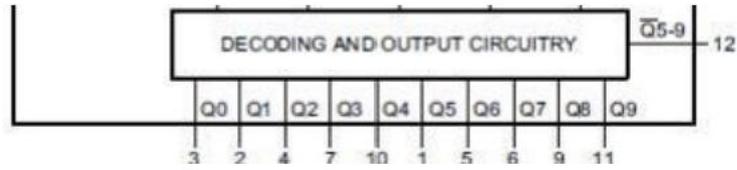


Figure 3 . Functional diagram

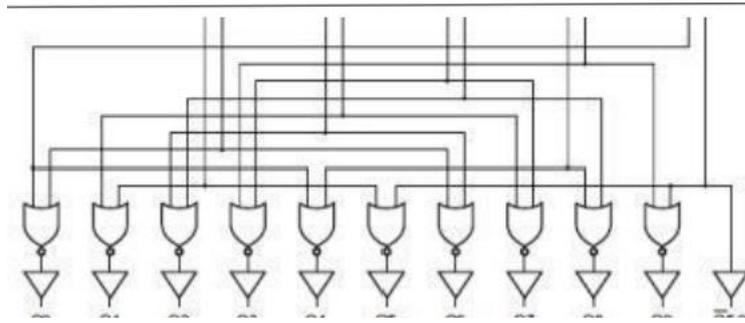


Figure 4. Logic diagram

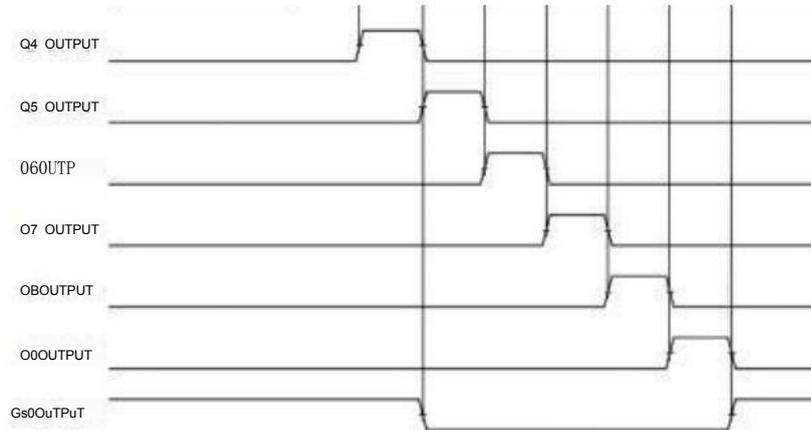
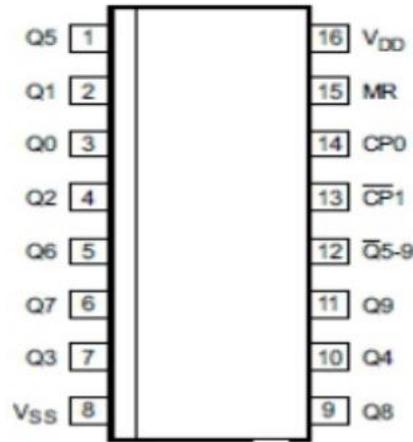


Figure 5. Timing diagram

## 2.2、Pin Configurations



## 2.3、Pin Description

Pin No	Pin Name	Description
1	Q5	decoded output
2	Q1	decoded output
3	Q0	decoded output
4	Q2	decoded output
5	Q6	decoded output
6	Q7	decoded output
7	Q3	decoded output
8	Vss	ground(0 V)
9	Q8	decoded output
10	Q4	decoded output
11	Q9	decoded output
12	Q5-9	carry output(active LOW)
13	CP1	clock input(HIGH-to-LOW edge-triggered)
14	CP0	clock input(LOW-to-HIGH edge-triggered)
15	MR	master reset input
16	VDD	supply voltage

## 2.4、Function Table

Input			Operation
MR	CP0	CP1	
H	X	X	Q0=Q5-9=H;Q1 toQ9=L
L	H	↓	counter advances
L	1	L	counter advances
L	L	X	no change
L	X	H	no change
L	H		no change
L	↓	L	no change

Note:H=HIGH voltage level;L=LOW voltage level;X=don't care,  
 ↑=positive-going transition; ↓=negative-going transition.

### 3 Electrical Parameter

#### 3.1 Absolute Maximum Ratings

(Voltages are referenced to Vss(ground=0 V),unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	VDD		-05	+18	V
DC input current	I <sub>ik</sub>	any one input		±10	mA
input voltage	V <sub>i</sub>	all inputs	-05	VDD+05	V
storage temperature	T <sub>stg</sub>		-65	+150	°C
total power dissipation	P <sub>tot</sub>			500	mW
device dissipation	P	per output transistor		100	mW
Soldering temperature	TL	10s	DIP	245	°C
			SOP	250	

Note:

[1]For DIP16 packages:above 70°C the value of P<sub>tot</sub> derates linearly with 12 mW/K.

[ 2 ]For SOP16 packages: above 70°C the value of P<sub>tot</sub> derates linearly with 8mW/K.

[3]For(T)SSOP16 packages:above 60°C the value of P<sub>tot</sub> derates linearly with 5.5mW/K.

#### 3.2 Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	VDD		3		15	V
ambient temperature	T <sub>amb</sub>	in free air	-40		+85	°C
clock input frequency	f <sub>cl</sub>	VDD=5V			2.5	MHz
		VDD=10V	-	-	5	MHz
		V <sub>pd</sub> =15V			5.5	MHz
clock pulse width	t <sub>w</sub>	V <sub>d</sub> =5 V	200			nS
		VDD=10V	90			nS
		VDD=15V	60			nS
clock rise and fall time	tr <sub>cl</sub> , tf <sub>cl</sub>	V <sub>Dp</sub> =5 V	unlimited			
		VDD=10V				
		VDD=15V				
clock inhibit setup time	t <sub>s</sub>	V <sub>d</sub> =5 V	230			nS
		VDD=10V	100			nS
		VDD=15V	70			ns
reset pulse width	t <sub>gw</sub>	V <sub>Dp</sub> =5 V	260			nS
		V <sub>d</sub> =10V	110			nS
		VDD=15V	60			nS
reset removal time	t <sub>ree</sub>	V <sub>Dp</sub> =5 V	400			nS
		VDD=10V	280			ns
		VDD=15V	150			ns

			0, 15	15		0.05		0.05	V
HIGH-level output voltage	V <sub>oh</sub>		0, 5	5	4.95		4.95		V
			0, 10	10	9.95	—	9.95	—	V
			0, 15	15	14.95		14.95		V
LOW-level input voltage	V <sub>μ</sub>	0.5, 4.5		5		1.5	—	1.5	V
		1, 9		10		3	—	3	V
		1.5, 13.5		15		4	—	4	V
HIGH-level input voltage	V <sub>iH</sub>	0.5, 4.5		5	3.5	—	3.5	—	V
		1, 9		10	7		7		V
		1.5, 13.5		15	11		11		V
input leakage current	I <sub>l</sub>		0, 15	15		±0.1		±1	uA

### 3.3.3、AC Characteristics

(T<sub>amb</sub>=25°C, V<sub>ss</sub>=0V, t<sub>r</sub>, t<sub>f</sub>=20ns, C<sub>L</sub>=50pF, R<sub>L</sub>=200kΩ, unless otherwise specified.)

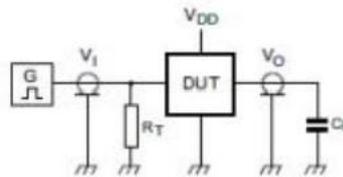
Parameter	Symbol	Conditions	Min.	Typ.	Max	Unit	
propagation delay time	t <sub>pHL</sub> , t <sub>pLH</sub>	CP0, CP1 to Q0 to Q9; see Figure 7	V <sub>dd</sub> =5V		325	650	ns
			V <sub>dp</sub> =10V		135	270	ns
			V <sub>dd</sub> =15V	—	85	170	ns
		CP0, CP1 to Q5-9; see Figure 7	V <sub>dd</sub> =5V		300	600	ns
			V <sub>dp</sub> =10V	—	125	250	ns
			V <sub>dp</sub> =15V	—	80	160	ns
		MR to Q0 to Q9; see Figure 7	V <sub>dp</sub> =5V	—	265	530	ns
			V <sub>dp</sub> =10V	—	115	230	ns
transition time	t <sub>t</sub>	see Figure 7	V <sub>dd</sub> =5V	—	100	200	ns
			V <sub>dp</sub> =10V		50	100	ns
			V <sub>dp</sub> =15V	—	40	80	ns
pulse width	t <sub>w</sub>	see Figure 8	V <sub>pd</sub> =5V		100	200	ns
			V <sub>dp</sub> =10V		45	90	ns
			V <sub>dd</sub> =15V		30	60	ns
clock rise and fall time	t <sub>cl</sub> , t <sub>icl</sub>		V <sub>DD</sub> =5V	unlimited			
			V <sub>dp</sub> =10V				
			V <sub>dd</sub> =15V				
maximum clock frequency	f <sub>cl</sub>	see Figure 8	V <sub>pd</sub> =5V	2.5	5	—	MHz
			V <sub>dp</sub> =10V	5	10	—	MHz
			V <sub>dp</sub> =15V	5.5	11		MHz
setup time	t <sub>s</sub>	CP0 to CPI see Figure 9	V <sub>pd</sub> =5V	—	115	230	ns
			V <sub>dp</sub> =10V		50	100	ns
			V <sub>dp</sub> =15V	—	35	70	ns
reset removal time	t <sub>rec</sub>	MR input; see Figure 8	V <sub>pd</sub> =5V	—	200	400	ns
			V <sub>dp</sub> =10V	—	140	280	ns
			V <sub>dp</sub> =15V		75	150	ns
input capacitance	C <sub>i</sub>	any input		5		pF	

Note: t<sub>t</sub> is the same as t<sub>rlh</sub> and t<sub>trh</sub>

## 4、Testing Circuit

### 4.1、AC Testing Circuit

a. Input waveforms



b. Test circuit

Figure 6. Test circuit for switching times

Definitions for test circuit:

DUT=Device Under Test.

CL=Load capacitance including jig and probe capacitance.

Rr=Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

### 4.2、AC Testing Waveforms

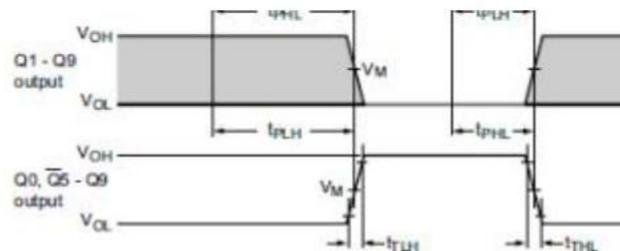


Figure 7. Waveforms showing the propagation delays for CP0, CP1 to Qn, Q5-9 outputs and the output transition times.

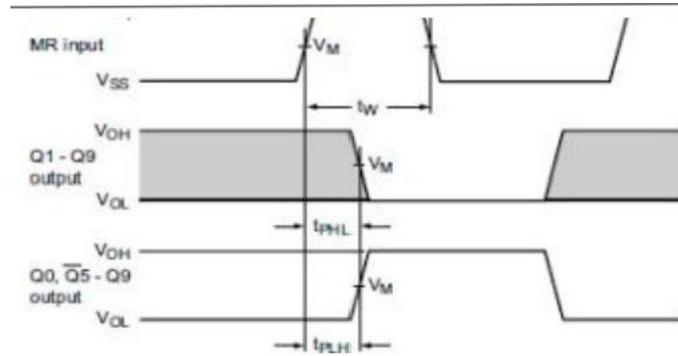


Figure 8. Waveforms showing the minimum pulse width for CP0, CP1 and MR input; the maximum

frequency for CPO and CP1 input; the recovery time for MR and the MR input to Qn and Q5-9 output propagation delay



Figure 9. Waveforms showing hold times for CPO to CPI and CP1 to CPO

#### 4.3 Measurement Points

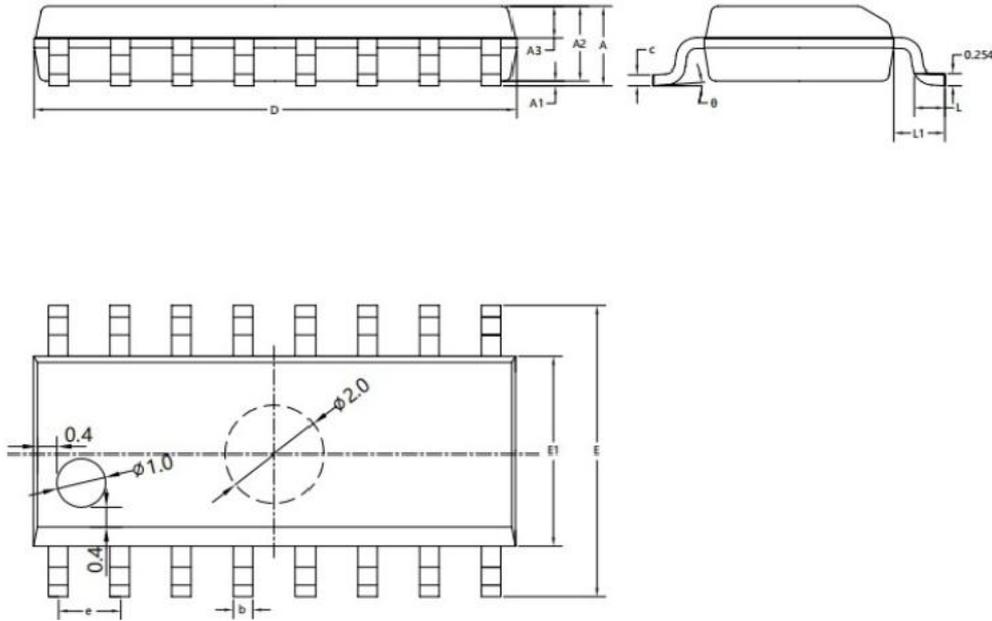
Supply voltage	Input	Output
VDD	V <sub>M</sub>	V <sub>M</sub>
5V to 15V	0.5 × VDD	0.5 × VDD

#### 4.4 Test Data

Supply voltage	Input		Load
VDD	V <sub>I</sub>	t <sub>r</sub> , t <sub>r</sub>	CL
5V to 15V	V <sub>SS</sub> or VDD	≤ 20ns	50pF

## 5、 Package Information

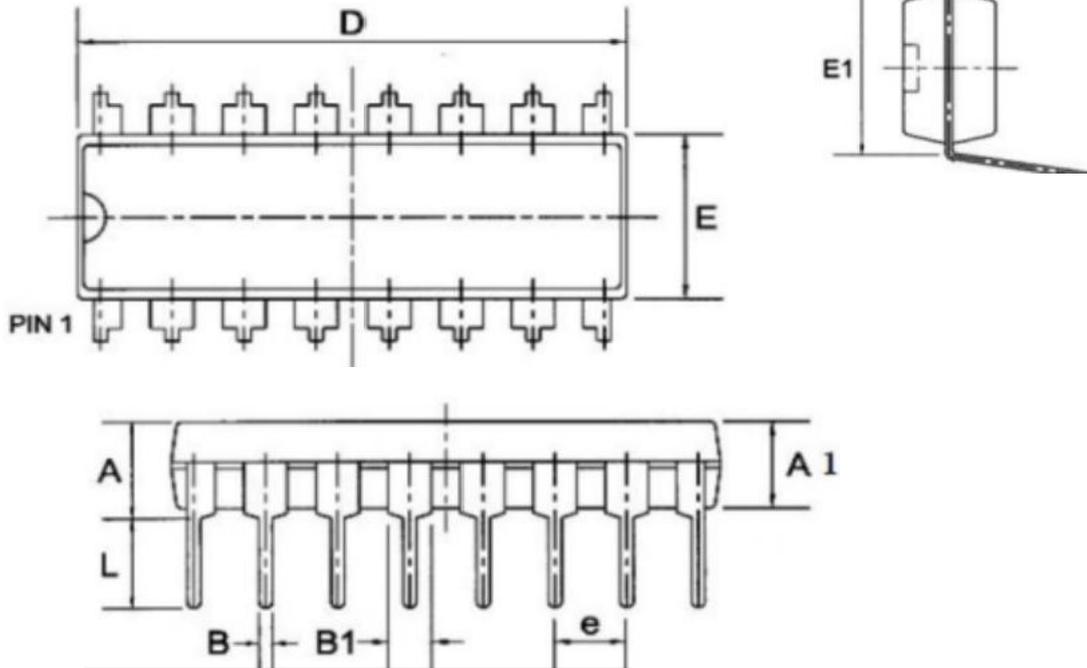
### 5.1、 DIP16



SYMBOL	MILLUMETER		
	MIN	NOM	MAX
A	1.50	1.60	1.70
A1	0.10	0.15	0.25
A2	1.40	1.45	1.50
A3	0.60	0.65	0.70
b	0.30	0.40	0.50
c	0.15	0.20	0.25
D	9.80	9.90	10.00
E	5.80	6.00	6.20
E1	3.85	3.90	3.95
e	1.27BSC		
L	0.50	0.60	0.70

L1	1.05BSC		
θ	0	4*	

5.2~SOP16



Symbol	Dimensions in Millimeters		
	Min	Nom	Max
A			4.31
A1	3.15	3.30	3.65
B		0.50	
B1		1.6	
C		0.27	
D	19.00	19.20	19.60
E	6.20	6.50	6.60
E1		8.0	
e		2.3	
L	3.00	3.20	3.60

